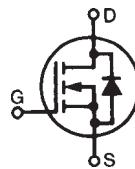
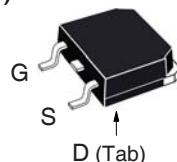
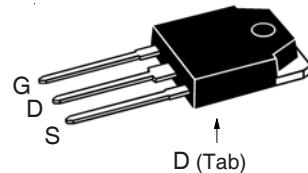
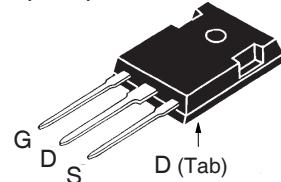


**Polar3™ HiperFET™  
Power MOSFET**
**IXFT94N30P3  
IXFQ94N30P3  
IXFH94N30P3**
 **$V_{DSS}$  = 300V  
 $I_{D25}$  = 94A  
 $R_{DS(on)}$  ≤ 36mΩ**

N-Channel Enhancement Mode  
Avalanche Rated  
Fast Intrinsic Rectifier

**TO-268 (IXFT)****TO-3P (IXFQ)****TO-247 (IXFH)**

G = Gate      D = Drain  
S = Source      Tab = Drain

Symbol	Test Conditions	Maximum Ratings	
$V_{DSS}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$	300	V
$V_{DGR}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ , $R_{GS} = 1\text{M}\Omega$	300	V
$V_{GSS}$	Continuous	± 20	V
$V_{GSM}$	Transient	± 30	V
$I_{D25}$	$T_c = 25^\circ\text{C}$	94	A
$I_{DM}$	$T_c = 25^\circ\text{C}$ , Pulse Width Limited by $T_{JM}$	235	A
$I_A$	$T_c = 25^\circ\text{C}$	47	A
$E_{AS}$	$T_c = 25^\circ\text{C}$	2.5	J
$dv/dt$	$I_S \leq I_{DM}$ , $V_{DD} \leq V_{DSS}$ , $T_J \leq 150^\circ\text{C}$	35	V/ns
$P_D$	$T_c = 25^\circ\text{C}$	1040	W
$T_J$		-55 ... +150	°C
$T_{JM}$		150	°C
$T_{stg}$		-55 ... +150	°C
$T_L$	Maximum Lead Temperature for Soldering	300	°C
$T_{SOLD}$	Plastic Body for 10s	260	°C
$M_d$	Mounting Torque (TO-247 & TO-3P)	1.13 / 10	Nm/lb.in
<b>Weight</b>	TO-268	4.0	g
	TO-3P	5.5	g
	TO-247	6.0	g

Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
$BV_{DSS}$	$V_{GS} = 0\text{V}$ , $I_D = 1\text{mA}$	300		V
$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 4\text{mA}$	3.0		V
$I_{GSS}$	$V_{GS} = \pm 20\text{V}$ , $V_{DS} = 0\text{V}$			$\pm 100$ nA
$I_{DSS}$	$V_{DS} = V_{DSS}$ , $V_{GS} = 0\text{V}$ $T_J = 125^\circ\text{C}$			25 $\mu\text{A}$ 750 $\mu\text{A}$
$R_{DS(on)}$	$V_{GS} = 10\text{V}$ , $I_D = 0.5 \cdot I_{D25}$ , Note 1			36 mΩ

**Features**

- Fast Intrinsic Rectifier
- Avalanche Rated
- Low  $R_{DS(on)}$  and  $Q_G$
- Low Package Inductance

**Advantages**

- High Power Density
- Easy to Mount
- Space Savings

**Applications**

- Switch-Mode and Resonant-Mode Power Supplies
- DC-DC Converters
- Laser Drivers
- AC and DC Motor Drives
- Robotics and Servo Controls

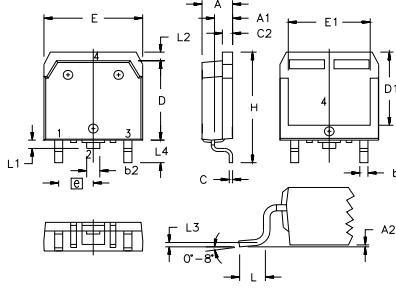
**Symbol      Test Conditions**  
 $(T_J = 25^\circ\text{C} \text{ Unless Otherwise Specified})$ 
**Characteristic Values**  
 Min.      Typ.      Max.

$g_{fs}$	$V_{DS} = 20\text{V}, I_D = 0.5 \cdot I_{D25}$ , Note 1	40	68	S
$C_{iss}$	$V_{GS} = 0\text{V}, V_{DS} = 25\text{V}, f = 1\text{MHz}$	5510	pF	
		965	pF	
		25	pF	
$R_{Gi}$	Gate Input Resistance	1.2	$\Omega$	
$t_{d(on)}$	<b>Resistive Switching Times</b> $V_{GS} = 10\text{V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 \cdot I_{D25}$ $R_G = 1\Omega$ (External)	23	ns	
		19	ns	
		49	ns	
		11	ns	
$Q_{g(on)}$	$V_{GS} = 10\text{V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 \cdot I_{D25}$	102	nC	
		33	nC	
		37	nC	
$R_{thJC}$			0.12 $^\circ\text{C}/\text{W}$	
$R_{thCS}$	(TO-247 & TO-3P)	0.25	$^\circ\text{C}/\text{W}$	

**Source-Drain Diode**
**Symbol      Test Conditions**  
 $(T_J = 25^\circ\text{C} \text{ Unless Otherwise Specified})$ 
**Characteristic Values**  
 Min.      Typ.      Max.

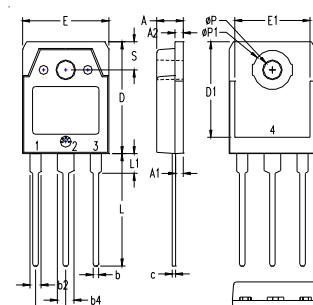
$I_s$	$V_{GS} = 0\text{V}$	94	A
$I_{SM}$	Repetitive, Pulse Width Limited by $T_{JM}$	376	A
$V_{SD}$	$I_F = I_s, V_{GS} = 0\text{V}$ , Note 1	1.5	V
$t_{rr}$	$I_F = 47\text{A}, -di/dt = 100\text{A}/\mu\text{s}$ $V_R = 100\text{V}, V_{GS} = 0\text{V}$	250	ns
		15.6	A
		1.4	$\mu\text{C}$

Note 1. Pulse test,  $t \leq 300\mu\text{s}$ , duty cycle,  $d \leq 2\%$ .

**TO-268 Outline**


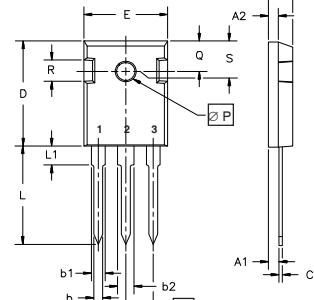
Terminals: 1 - Gate    2, 4 - Drain  
3 - Source

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.193	.201	4.90	5.10
A1	.106	.114	2.70	2.90
A2	.001	.010	0.02	0.25
b	.045	.057	1.15	1.45
b2	.075	.083	1.90	2.10
C	.016	.026	0.40	0.65
C2	.057	.063	1.45	1.60
D	.543	.551	13.80	14.00
D1	.488	.500	12.40	12.70
E	.624	.632	15.85	16.05
E1	.524	.535	13.30	13.60
e	.215	BSC	5.45	BSC
H	.736	.752	18.70	19.10
L	.094	.106	2.40	2.70
L1	.047	.055	1.20	1.40
L2	.039	.045	1.00	1.15
L3	.010	BSC	0.25	BSC
L4	.150	.161	3.80	4.10

**TO-3P Outline**


1 - GATE  
2 - DRAIN  
3 - SOURCE  
4 - DRAIN

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.185	.193	4.70	4.90
A1	.051	.059	1.30	1.50
A2	.057	.065	1.45	1.65
b	.035	.045	0.90	1.15
b2	.075	.087	1.90	2.20
b4	.114	.126	2.90	3.20
c	.022	.031	0.55	0.80
D	.780	.799	19.80	20.30
D1	.665	.677	16.90	17.20
E	.610	.622	15.50	15.80
E1	.531	.539	13.50	13.70
e	.215	BSC	5.45	BSC
L	.779	.795	19.80	20.20
L1	.134	.142	3.40	3.60
ØP	.126	.134	3.20	3.40
ØP1	.272	.280	6.90	7.10
S	.193	.201	4.90	5.10

**TO-247 Outline**


Terminals: 1 - Gate    2 - Drain  
3 - Source

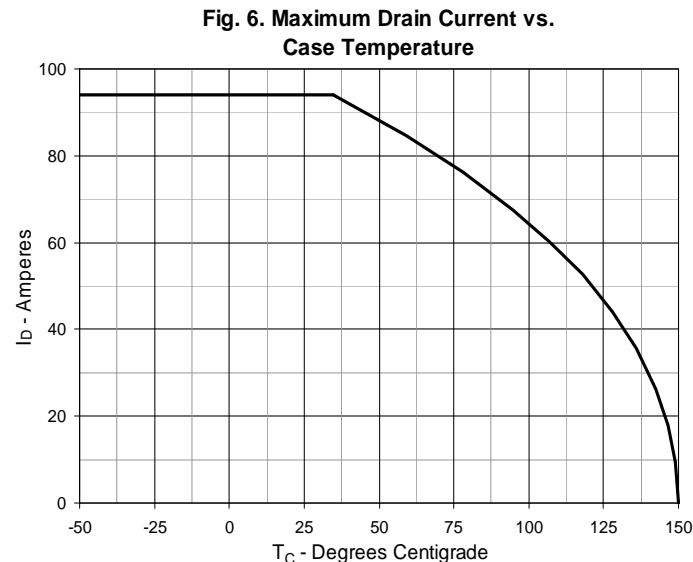
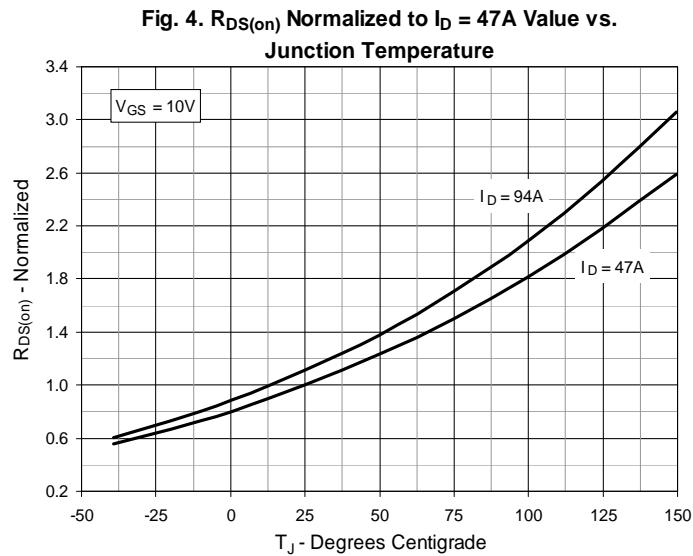
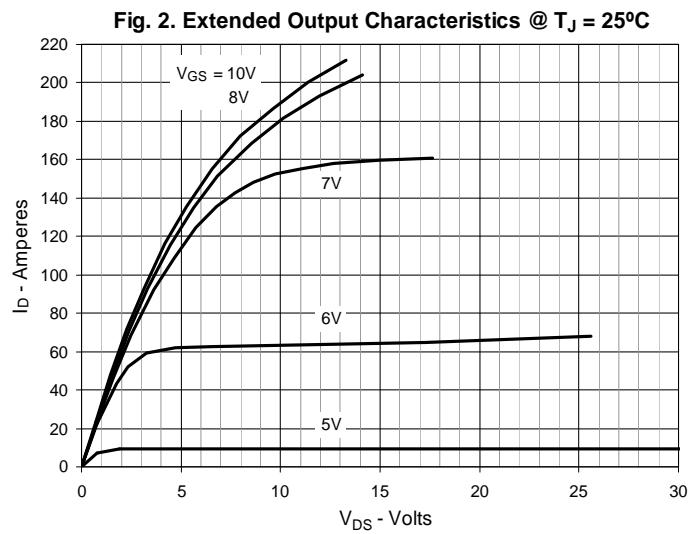
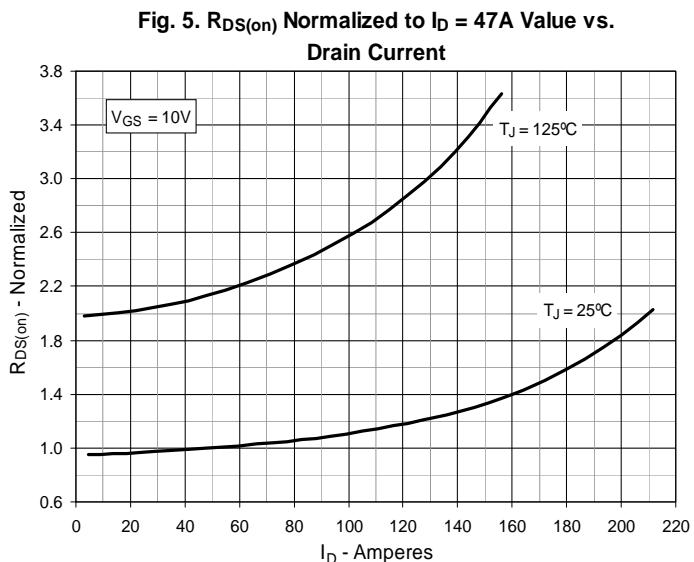
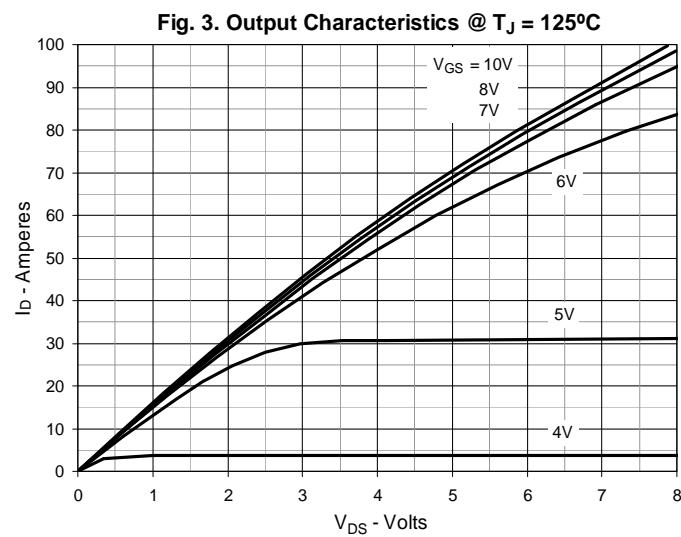
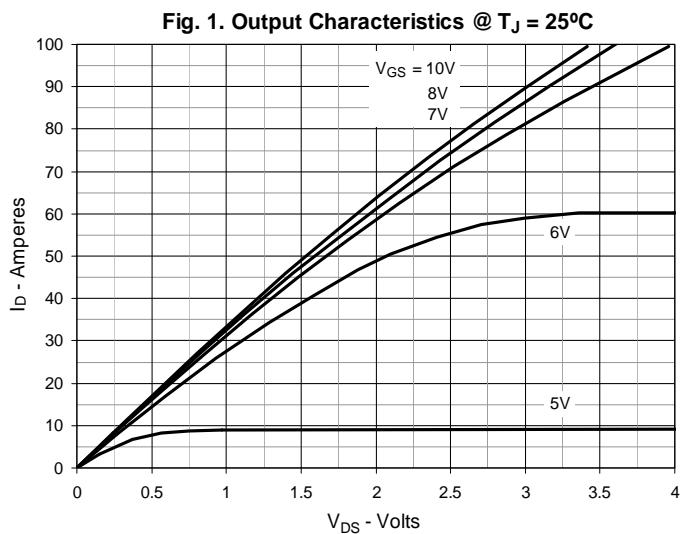
Dim.	Millimeter	Inches
	Min.	Max.
A	4.7	.185
A <sub>1</sub>	2.2	.087
A <sub>2</sub>	2.2	.098
b	1.0	.040
b <sub>1</sub>	1.65	.065
b <sub>2</sub>	2.87	.113
C	.4	.016
D	20.80	1.4
E	15.75	.845
e	5.20	.205
L	19.81	.800
L1	4.50	.177
ØP	3.55	.144
Q	5.89	.232
R	4.32	.170
S	6.15	.216
	BSC	BSC

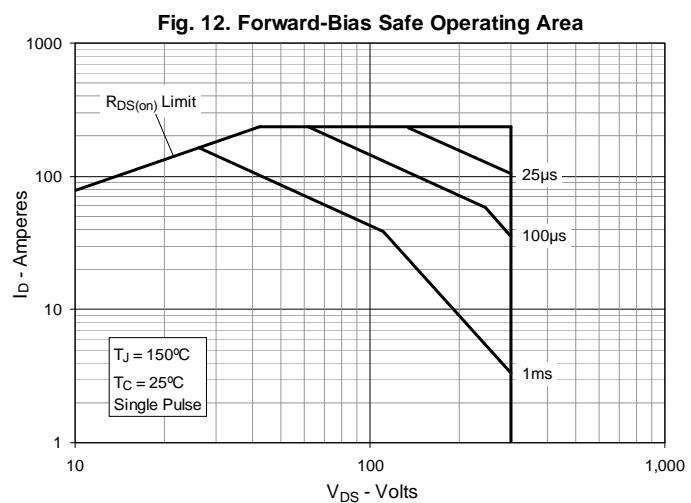
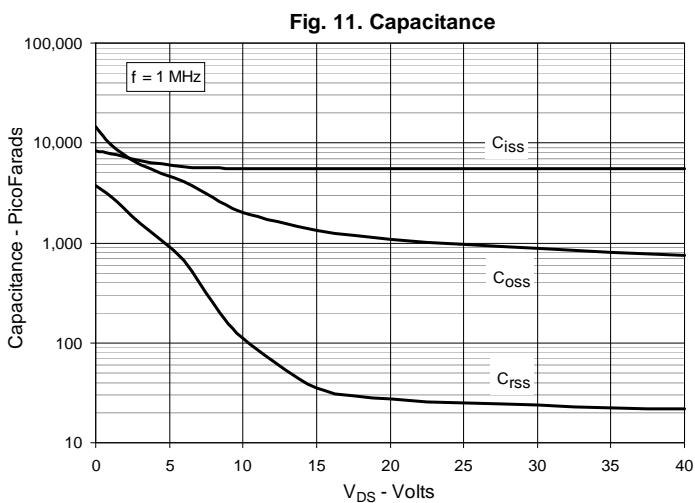
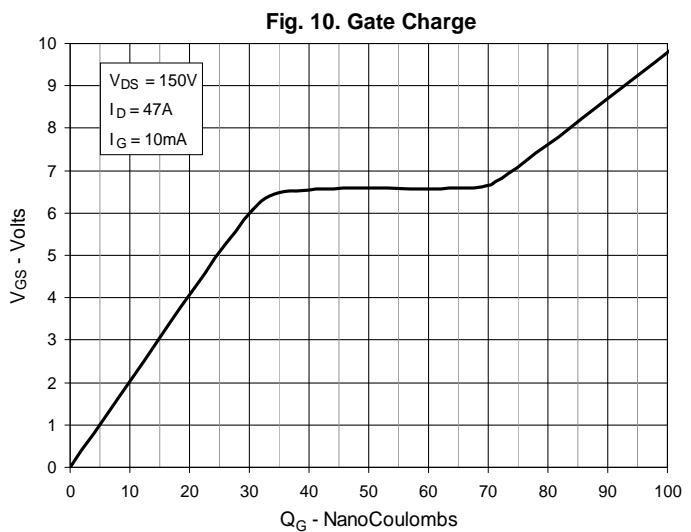
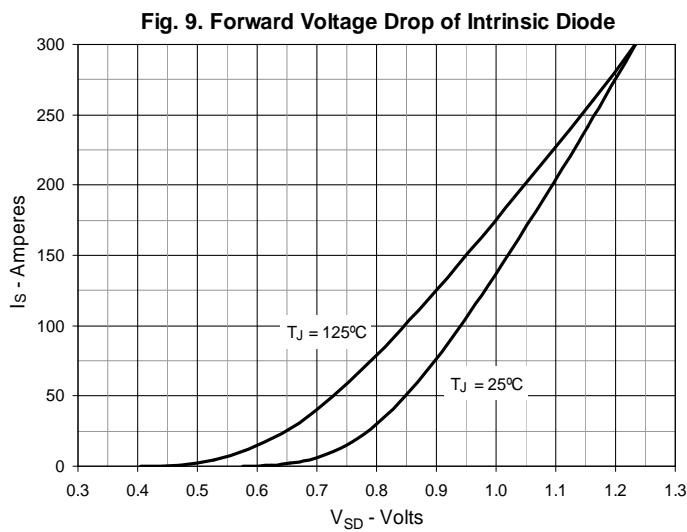
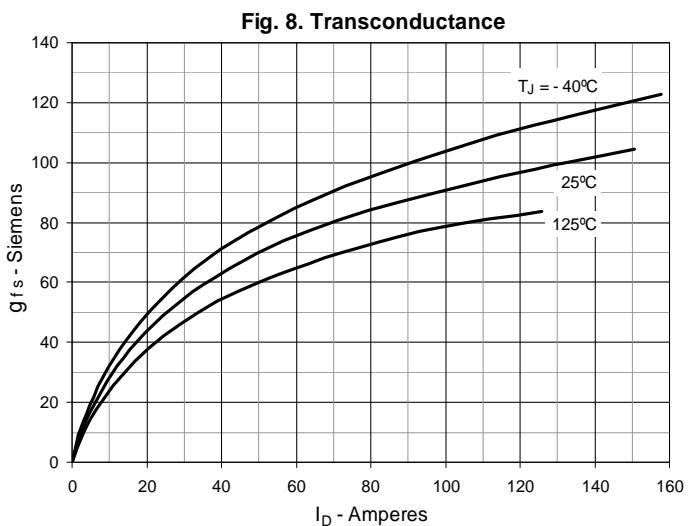
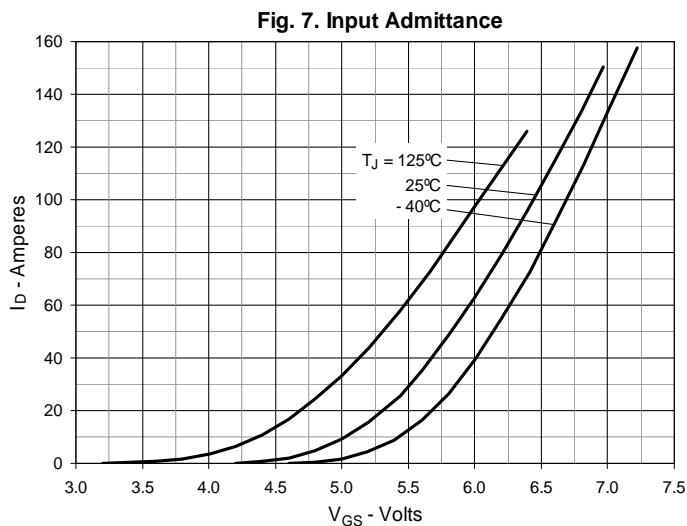
**PRELIMINARY TECHNICAL INFORMATION**

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2 4,860,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537





**Fig. 13. Maximum Transient Thermal Impedance**